

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
TAKATSUGU NEMOTO	07/14/2014
YASUTAKA NAKASHIBA	07/14/2014
TAKASUKE HASHIMOTO	07/13/2014
SHINICHI UCHIDA	07/15/2014
KAZUNORI GO	07/22/2014
HIROSHI OE	07/16/2014
NORIKO YOSHIKAWA	07/18/2014
RECEIVING PARTY DATA	
Name:	RENESAS ELECTRONICS CORPORATION
Street Address:	1753, SHIMONUMABE, NAKAHARA-KU
City:	KAWASAKI-SHI, KANAGAWA
State/Country:	JAPAN
Postal Code:	211-8668
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14475623
CORRESPONDENCE DATA	
Fax Number:	(703)610-8686
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	7039039000
Email:	tpurifoy@milesstockbridge.com
Correspondent Name:	MITCHELL W. SHAPIRO
Address Line 1:	MILES & STOCKBRIDGE P.C.
Address Line 2:	1751 PINNACLE DRIVE, SUITE 1500
Address Line 4:	TYSONS CORNER, VIRGINIA 22102-3833
ATTORNEY DOCKET NUMBER:	XA-12701/T9104-20946US01
NAME OF SUBMITTER:	TYNISHA PURIFOY
SIGNATURE:	/Tynisha Purifoy/
DATE SIGNED:	09/05/2014

PATENT

Total Attachments: 4

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ASSIGNMENT

(譲 渡 証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Renesas Electronics Corporation, a corporation organized under the laws of Japan, located at 1753, Shimonumabe, Nakahara-ku, Kawasaki-shi, Kanagawa, 211-8668, Japan, receipt of which is hereby acknowledged, I do hereby sell and assign to said Renesas Electronics Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

SENSOR DEVICE

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said Renesas Electronics Corporation, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Renesas Electronics Corporation.

Signed on the date(s) indicated aside our signatures:

INVENTOR(S)

(発 明 者 フ ル ネ ー ム サ イ ン)

Date Signed

(署 名 日)

1) Takatsugu Nemoto
Takatsugu NEMOTO

July 14, 2014

2) _____
Yasutaka NAKASHIBA

3) _____
Takasuke HASHIMOTO

4) _____
Shinichi UCHIDA

5) _____
Kazunori GO

6) _____
Hiroshi OE

7) _____
Noriko YOSHIKAWA

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INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
1) _____ Takatsugu NEMOTO	_____
2) <u>Yasutaka Nakashiba</u> Yasutaka NAKASHIBA	<u>July 14, 2014</u>
3) _____ Takasuke HASHIMOTO	_____
4) <u>Shinichi Uchida</u> Shinichi UCHIDA	<u>July 15, 2014</u>
5) _____ Kazunori GO	_____
6) _____ Hiroshi OE	_____
7) _____ Noriko YOSHIKAWA	_____

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6) _____ <i>Hiroshi OE</i> Hiroshi OE	_____ <i>July 16, 2014</i>
7) _____ <i>Noriko YOSHIKAWA</i> Noriko YOSHIKAWA	_____ <i>July 18, 2014</i>